

EAST - [silicone compounds.wsp:1]

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[[257/706].CCLS.] and [via or hole]] and wire

118) [(organopolysiloxane and organohy
 110) [(organopolysiloxane and organoh
 2) [(organopolysiloxane and organohydrogenpolysiloxane) and (filler or (powder or (zinc or...
 49) [(organopolysiloxane and organoh
 2) ["5723904"].PN.
 3) 794065.ap.
 3) ["4805009"].PN.
 4) 816665.ap.
 1) ["0878815"].PN.
 4) 878815.ap.
 4) 713834.ap.
 603) [257/783].CCLS.
 794) [257/706].CCLS.
 0) ["2 and (via or hole)"].PN.
 408) [[257/706].CCLS.] and (via or hole)
 227) [[[257/706].CCLS.] and (via or hole)]

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	U	I	Document ID	Issue Date	Pages	Title	Current OR	Current XRef
1	<input type="checkbox"/>	<input type="checkbox"/>	US 20020074646 A1	20020620	13	Non-rectangular thermo module wafer cooling device using the same	257/706	257/712; 257/717;
2	<input type="checkbox"/>	<input type="checkbox"/>	US 20020063327 A1	20020530	10	Electronic module with integrated programmable thermoelectric cooling	257/706	136/201; 136/203;
3	<input type="checkbox"/>	<input type="checkbox"/>	US 20020060369 A1	20020523	20	BOARD-ON-CHIP PACKAGES WITH CONDUCTIVE FOIL ON THE CHIP SURFACE	257/782	257/668; 257/706;
4	<input type="checkbox"/>	<input type="checkbox"/>	US 20020041022 A1	20020411	30	Radiation substrate and semiconductor module	257/701	257/706; 257/778
5	<input type="checkbox"/>	<input type="checkbox"/>	US 20020024132 A1	20020228	11	SEMICONDUCTOR DEVICE WITH INTERNAL HEAT DISSIPATION	257/706	257/707; 257/713;
6	<input type="checkbox"/>	<input type="checkbox"/>	US 20020017714 A1	20020214	12	Electrically isolated power semiconductor package	257/706	257/706;
7	<input type="checkbox"/>	<input type="checkbox"/>	US 20010045643 A1	20011129	19	SEMICONDUCTOR DEVICE KEEPING STRUCTURAL INTEGRITY UNDER	257/706	257/737; 257/787;

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4/12/02